![Texas Instruments logo]

5-V/3.3-V SINGLE-CHANNEL 2:1 MULTIPLEXER/DEMULTIPLEXER

FEATURES

- **Specified Make-Before-Break Switching**
- **Low ON-State Resistance (0.9 Ω)**
- **Control Inputs Are 5.5-V Tolerant**
- **Low Charge Injection**
- **Excellent ON-State Resistance Matching**
- **Low Total Harmonic Distortion (THD)**
- **1.65-V to 5.5-V Single-Supply Operation**
- **Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II**
- **ESD Performance Tested Per JESD 22**
  - **2000-V Human-Body Model (A114-B, Class II)**
  - **1000-V Charged-Device Model (C101)**

APPLICATIONS

- **Cell Phones**
- **PDAs**
- **Portable Instrumentation**
- **Audio and Video Signal Routing**
- **Low-Voltage Data-Acquisition Systems**
- **Communication Circuits**
- **Modems**
- **Hard Drives**
- **Computer Peripherals**
- **Wireless Terminals and Peripherals**
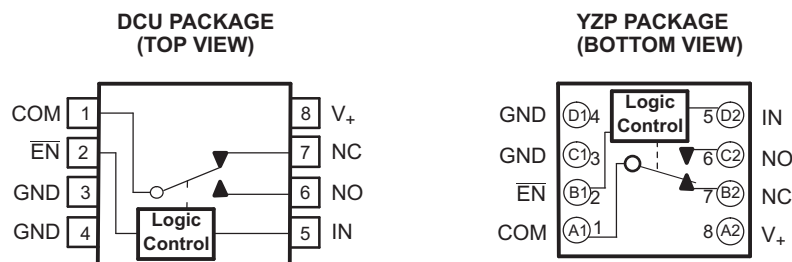
DESCRIPTION/ORDERING INFORMATION

The TS5A3154 is a single-pole double-throw (SPDT) analog switch that is designed to operate from 1.65 V to 5.5 V. The device offers a low ON-state resistance and an excellent channel-to-channel ON-state resistance matching. The device has excellent total harmonic distortion (THD) performance and consumes very low power. These features make this device suitable for portable audio applications.

ORDERING INFORMATION

T$_A$	PACKAGE[1][2]		ORDERABLE PART NUMBER	TOP-SIDE MARKING[3]
–40°C to 85°C	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)	Reel of 3000	TS5A3157YZPR	_ _ _JX_
	SSOP – DCU	Reel of 3000	TS5A3157DCUR	JCF_

(1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.
(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.
(3) DCU: The actual top-side marking has one additional character that designates the assembly/test site.
   YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).

⚠ Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

NanoFree is a trademark of Texas Instruments.

FUNCTION TABLE

$\overline{EN}$	IN	NC TO COM, COM TO NC	NO TO COM, COM TO NO
L	L	ON	OFF
L	H	OFF	ON
H	X	OFF	OFF

Summary of Characteristics[1]

Configuration	Single-Pole, Double-Throw 2:1 Multiplexer/Demultiplexer (SPDT)
Number of channels	1
ON-state resistance (r_{on})	0.9 Ω
ON-state resistance match (Δr_{on})	0.1 Ω
ON-state resistance flatness ($r_{on(flat)}$)	0.15 Ω
Turn-on/turn-off time (t_{ON}/t_{OFF})	8 ns/12.5 ns
Make-before-break time (t_{MBB})	12 ns
Charge injection (Q_C)	10 pC
Bandwidth (BW)	100 MHz
OFF isolation (O_{ISO})	–64 dB at 1 MHz
Crosstalk (X_{TALK})	–64 dB at 1 MHz
Total harmonic distortion (THD)	0.004%
Leakage current ($I_{COM(OFF)}/I_{NC(OFF)}$)	±20 nA
Power-supply current (I_+)	0.1 µA
Package option	8-pin SSOP or DSBGA

(1) $V_+ = 5$ V, $T_A = 25°C$

Absolute Minimum and Maximum Ratings[1][2]

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_+	Supply voltage range[3]		−0.5	6.5	V
V_{NC}, V_{NO}, V_{COM}	Analog voltage range[3][4][5]		−0.5	$V_+ + 0.5$	V
I_K	Analog port diode current	V_{NC}, V_{NO}, $V_{COM} < 0$ or V_{NO}, V_{NC}, $V_{COM} > V_+$	−50	50	mA
I_{NC}, I_{COM}, I_{NO}	On-state switch current	V_{NC}, V_{NO}, $V_{COM} = 0$ to V_+	−200	200	mA
	On-state peak switch current[6]		−400	400	
V_I	Digital input voltage range[3][4]		−0.5	6.5	V
I_{IK}	Digital input clamp current	$V_I < 0$	−50		mA
I_+	Continuous current through V_+			100	mA
I_{GND}	Continuous current through GND		−100	100	mA
θ_{JA}	Package thermal impedance[7]	DCU package		227	°C/W
		YZP package		102	
T_{stg}	Storage temperature range		−65	150	°C

(1)   Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
(2)   The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(3)   All voltages are with respect to ground, unless otherwise specified.
(4)   The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
(5)   This value is limited to 5.5 V maximum.
(6)   Pulse at 1-ms duration < 10% duty cycle.
(7)   The package thermal impedance is calculated in accordance with JESD 51-7.

Product Folder Link(s): TS5A3154

TS5A3154

Electrical Characteristics for 5-V Supply[1]

V_+ = 4.5 V to 5.5 V, T_A = −40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T_A	V_+	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V_{COM}, V_{NO}, V_{NC}					0		V_+	V
Peak ON resistance	r_{peak}	0 ≤ (V_{NO} or V_{NC}) ≤ V_+, I_{COM} = −100 mA,	Switch ON, See Figure 13	25°C	4.5 V		0.9	1.1	Ω
				Full				1.3	
ON-state resistance	r_{on}	V_{NO} or V_{NC} = 2.5 V, I_{COM} = −100 mA,	Switch ON, See Figure 13	25°C	4.5 V		0.8	0.9	Ω
				Full				1.1	
ON-state resistance matching between channels	Δr_{on}	V_{NO} or V_{NC} = 2.5 V, I_{COM} = −100 mA,	Switch ON, See Figure 13	25°C	4.5 V		0.05	0.1	Ω
				Full				0.1	
ON-state resistance flatness	$r_{on(flat)}$	0 ≤ (V_{NO} or V_{NC}) ≤ V_+, I_{COM} = −100 mA,	Switch ON, See Figure 13	25°C	4.5 V		0.15		Ω
				Full					
		V_{NO} or V_{NC} = 1 V, 1.5 V, 2.5 V, I_{COM} = −100 mA,	Switch ON, See Figure 13	25°C			0.09	0.15	
				Full				0.15	
NC, NO OFF leakage current	$I_{NC(OFF)}$, $I_{NO(OFF)}$	V_{NC} or V_{NO} = 1 V, V_{COM} = 4.5 V, or V_{NC} or V_{NO} = 4.5 V, V_{COM} = 1 V,	Switch OFF, See Figure 14	25°C	5.5 V	−20	2	20	nA
				Full		−150		150	
	$I_{NC(PWROFF)}$, $I_{NO(PWROFF)}$	V_{NC} or V_{NO} = 0 to 5.5 V, V_{COM} = 5.5 V to 0,	Switch OFF, See Figure 14	25°C	0 V	−5	0.7	5	μA
				Full		−25		25	
NC, NO ON leakage current	$I_{NC(ON)}$, $I_{NO(ON)}$	V_{NC} or V_{NO} = 1 V, V_{COM} = Open, or V_{NC} or V_{NO} = 4.5 V, V_{COM} = Open,	Switch ON, See Figure 15	25°C	5.5 V	−20	2	20	nA
				Full		−150		150	
COM OFF leakage current	$I_{COM(OFF)}$	V_{COM} = 1 V, V_{NC} or V_{NO} = 4.5 V, or V_{COM} = 4.5 V, V_{NC} or V_{NO} = 1 V,	Switch OFF, See Figure 14	25°C	5.5 V	−20	2	20	nA
				Full		−150		150	
	$I_{COM(PWROFF)}$	V_{NC} or V_{NO} = 0 to 5.5 V, V_{COM} = 5.5 V to 0,	Switch OFF, See Figure 14	25°C	0 V	−5	0.7	5	μA
				Full		−25		25	
COM ON leakage current	$I_{COM(ON)}$	V_{COM} = 1 V, V_{NC} or V_{NO} = Open, or V_{COM} = 4.5 V, V_{NC} or V_{NO} = Open,	Switch ON, See Figure 15	25°C	5.5 V	−20	2	20	nA
				Full		−150		150	
Digital Control Inputs (IN, $\overline{EN}$)[2]									
Input logic high	V_{IH}			Full		2.4		5.5	V
Input logic low	V_{IL}			Full		0		0.8	V
Input leakage current	I_{IH}, I_{IL}	V_I = 5.5 V or 0 V		25°C	5.5 V	−100	25	100	nA
				Full		−100		100	

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.
(2) All unused digital inputs of the device must be held at V_+ or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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Electrical Characteristics for 5-V Supply (continued)

V_+ = 4.5 V to 5.5 V, T_A = −40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T_A	V_+	MIN	TYP	MAX	UNIT
Dynamic									
Turn-on time, IN or $\overline{OE}$	t_{ON}	$V_{COM} = V_+$, R_L = 50 Ω,	C_L = 35 pF, See Figure 17	25°C	5 V	1	5.2	8	ns
				Full	4.5 V to 5.5 V	1		9	
Turn-off time, IN or $\overline{OE}$	t_{OFF}	$V_{COM} = V_+$, R_L = 50 Ω,	C_L = 35 pF, See Figure 17	25°C	5 V	5	9.5	12.5	ns
				Full	4.5 V to 5.5 V	4		13.5	
Make-before-break time	t_{MBB}	$V_{COM} = V_+$, R_L = 50 Ω,	C_L = 35 pF, See Figure 18	25°C	5 V	4	6.3	12	ns
				Full	4.5 V to 5.5 V	4		13	
Charge injection	Q_C	$V_{GEN} = 0$, $R_{GEN} = 0$,	C_L = 1 nF, See Figure 22	25°C	5 V		10		pC
NC, NO OFF capacitance	$C_{NC(OFF)}$, $C_{NO(OFF)}$	V_{NC} or $V_{NO} = V_+$ or GND,	Switch OFF, See Figure 16	25°C	5 V		19		pF
NC, NO ON capacitance	$C_{NC(ON)}$, $C_{NO(ON)}$	V_{NC} or $V_{NO} = V_+$ or GND,	Switch ON, See Figure 16	25°C	5 V		57		pF
COM OFF capacitance	$C_{COM(OFF)}$	$V_{COM} = V_+$ or GND,	Switch ON, See Figure 16	25°C	5 V		36		pF
COM ON capacitance	$C_{COM(ON)}$	$V_{COM} = V_+$ or GND,	Switch ON, See Figure 16	25°C	5 V		57		pF
Digital input capacitance	C_I	$V_I = V_+$ or GND,	See Figure 16	25°C	5 V		2		pF
Bandwidth	BW	R_L = 50 Ω,	Switch ON, See Figure 19	25°C	5 V		100		MHz
OFF isolation	O_{ISO}	R_L = 50 Ω, f = 1 MHz,	Switch OFF, See Figure 20	25°C	5 V		−64		dB
Crosstalk	X_{TALK}	R_L = 50 Ω, f = 1 MHz,	Switch ON, See Figure 21	25°C	5 V		−64		dB
Total harmonic distortion	THD	R_L = 600 Ω, C_L = 50 pF,	f = 20 Hz to 20 kHz, See Figure 23	25°C	5 V		0.004		%
Supply									
Positive supply current	I_+	$V_I = V_+$ or GND,	Switch ON or OFF	25°C	5.5 V		0.02	0.1	μA
				Full				0.5	

Electrical Characteristics for 3.3-V Supply[1]

V_+ = 3 V to 3.6 V, T_A = −40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T_A	V+	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V_{COM}, V_{NO}, V_{NC}					0		V_+	V
Peak ON resistance	r_{peak}	$0 \leq$ (V_{NO} or V_{NC}) $\leq V_+$, I_{COM} = −100 mA,	Switch ON, See Figure 13	25°C	3 V		1.3	1.6	Ω
				Full				1.9	
ON-state resistance	r_{on}	V_{NO} or V_{NC} = 2 V, I_{COM} = −100 mA,	Switch ON, See Figure 13	25°C	3 V		1.2	1.5	Ω
				Full				1.7	
ON-state resistance match between channels	Δr_{on}	V_{NO} or V_{NC} = 2 V, 0.8 V I_{COM} = −100 mA,	Switch ON, See Figure 13	25°C	3 V		0.08	0.15	Ω
				Full				0.15	
ON-state resistance flatness	$r_{on(flat)}$	$0 \leq$ (V_{NO} or V_{NC}) $\leq V_+$, I_{COM} = −100 mA,	Switch ON, See Figure 13	25°C	3 V		0.3		Ω
				Full					
		V_{NO} or V_{NC} = 2 V, 0.8 V, I_{COM} = −100 mA,	Switch ON, See Figure 13	25°C			0.09	0.15	
				Full				0.15	
NC, NO OFF leakage current	$I_{NC(OFF)}$, $I_{NO(OFF)}$	V_{NC} or V_{NO} = 1 V, V_{COM} = 3 V, or V_{NC} or V_{NO} = 3 V, V_{COM} = 1 V,	Switch OFF, See Figure 14	25°C	3.6 V	−20	2	20	nA
				Full		−50		50	
	$I_{NC(PWROFF)}$, $I_{NO(PWROFF)}$	V_{NC} or V_{NO} = 0 to 3.6 V, V_{COM} = 3.6 V to 0 V,	Switch OFF, See Figure 14	25°C	0 V	−1	0.2	1	μA
				Full		−15		15	
NC, NO ON leakage current	$I_{NC(ON)}$, $I_{NO(ON)}$	V_{NC} or V_{NO} = 1 V, V_{COM} = Open, or V_{NC} or V_{NO} = 3 V, V_{COM} = Open,	Switch ON, See Figure 15	25°C	3.6 V	−20	2	20	nA
				Full		−50		50	
COM OFF leakage current	$I_{COM(OFF)}$	V_{COM} = 1 V, V_{NC} or V_{NO} = 3 V, or V_{COM} = 3 V, V_{NC} or V_{NO} = 1 V,	Switch OFF, See Figure 14	25°C	3.6 V	−20	2	20	nA
				Full		−50		50	
	$I_{COM(PWROFF)}$	V_{NC} or V_{NO} = 0 to 3.6 V, V_{COM} = 3.6 V to 0,	Switch OFF, See Figure 14	25°C	0 V	−1	0.2	1	μA
				Full		−15		15	
COM ON leakage current	$I_{COM(ON)}$	V_{COM} = 1 V, V_{NC} or V_{NO} = Open, or V_{COM} = 3 V, V_{NC} or V_{NO} = Open	Switch ON, See Figure 15	25°C	3.6 V	−20	2	20	nA
				Full		−50		50	
Digital Control Inputs (IN, $\overline{EN}$)[2]									
Input logic high	V_{IH}			Full		2		5.5	V
Input logic low	V_{IL}			Full		0		0.8	V
Input leakage current	I_{IH}, I_{IL}	V_I = 5.5 V or 0		25°C	3.6 V	−100	25	100	nA
				Full		−100		100	

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.
(2) All unused digital inputs of the device must be held at V_+ or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

Electrical Characteristics for 3.3-V Supply (continued)

V_+ = 3 V to 3.6 V, T_A = –40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T_A	V+	MIN	TYP	MAX	UNIT
Dynamic									
Turn-on time, IN or $\overline{OE}$	t_{ON}	V_{COM} = V_+, R_L = 50 Ω,	C_L = 35 pF, See Figure 17	25°C	3.3 V	3	6	10	ns
				Full	3 V to 3.6 V	2		10.5	
Turn-off time, IN or $\overline{OE}$	t_{OFF}	V_{COM} = V_+, R_L = 50 Ω,	C_L = 35 pF, See Figure 17	25°C	3.3 V	5	10	15	ns
				Full	3 V to 3.6 V	4		17	
Make-before-break time	t_{MBB}	V_{COM} = V_+, R_L = 50 Ω,	C_L = 35 pF, See Figure 18	25°C	3.3 V	4	5.7	12	ns
				Full	3 V to 3.6 V	4		13	
Charge injection	Q_C	V_{GEN} = 0, R_{GEN} = 0,	C_L = 1 nF, See Figure 22	25°C	3.3 V		9		pC
NC, NO OFF capacitance	$C_{NC(OFF)}$, $C_{NO(OFF)}$	V_{NC} or V_{NO} = V_+ or GND,	Switch OFF, See Figure 16	25°C	3.3 V		19		pF
NC, NO ON capacitance	$C_{NC(ON)}$, $C_{NO(ON)}$	V_{NC} or V_{NO} = V_+ or GND,	Switch ON, See Figure 16	25°C	3.3 V		57		pF
COM OFF capacitance	$C_{COM(OFF)}$	V_{COM} = V_+ or GND,	Switch ON, See	25°C	3.3 V		36		pF
COM ON capacitance	$C_{COM(ON)}$	V_{COM} = V_+ or GND,	Switch ON, See Figure 16	25°C	3.3 V		57		pF
Digital input capacitance	C_I	V_I = V_+ or GND,	See Figure 16	25°C	3.3 V		2		pF
Bandwidth	BW	R_L = 50 Ω,	Switch ON, See Figure 19	25°C	3.3 V		100		MHz
OFF isolation	O_{ISO}	R_L = 50 Ω, f = 1 MHz,	Switch OFF, See Figure 20	25°C	3.3 V		–64		dB
Crosstalk	X_{TALK}	R_L = 50 Ω, f = 1 MHz,	Switch ON, See Figure 21	25°C	3.3 V		–64		dB
Total harmonic distortion	THD	R_L = 600 Ω, C_L = 50 pF,	f = 20 Hz to 20 kHz, See Figure 23	25°C	3.3 V		0.010		%
Supply									
Positive supply current	I_+	V_I = V_+ or GND,	Switch ON or OFF	25°C	3.6 V		0.01	0.1	μA
				Full				0.25	

Electrical Characteristics for 2.5-V Supply[1]

V_+ = 3 V to 3.6 V, T_A = −40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T_A	V_+	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V_{COM}, V_{NO}, V_{NC}					0		V_+	V
Peak ON resistance	r_{peak}	$0 \leq (V_{NO}$ or $V_{NC}) \leq V_+$, I_{COM} = −8 mA,	Switch ON, See Figure 13	25°C	2.3 V		1.9	2.5	Ω
				Full				2.7	
ON-state resistance	r_{on}	V_{NO} or V_{NC} = 1.8 V, I_{COM} = −8 mA,	Switch ON, See Figure 13	25°C	2.3 V		1.6	2.1	Ω
				Full				2.5	
ON-state resistance matching between channels	Δr_{on}	V_{NO} or V_{NC} = 1.8 V, I_{COM} = −8 mA,	Switch ON, See Figure 13	25°C	2.3 V		0.12	0.2	Ω
				Full				0.2	
ON-state resistance flatness	$r_{on(flat)}$	$0 \leq (V_{NO}$ or $V_{NC}) \leq V_+$, I_{COM} = −8 mA,	Switch ON, See Figure 13	25°C	2.3 V		0.65		Ω
				Full					
		V_{NO} or V_{NC} = 0.8 V, 1.8 V, I_{COM} = −8 mA,	Switch ON, See Figure 13	25°C			0.5	1	
				Full				1	
NC, NO OFF leakage current	$I_{NC(OFF)}$, $I_{NO(OFF)}$	V_{NC} or V_{NO} = 0.5 V, V_{COM} = 2.3 V, or V_{NC} or V_{NO} = 2.3 V, V_{COM} = 0.5 V,	Switch OFF, See Figure 14	25°C	2.7 V	−20	2	20	nA
				Full		−50		50	
	$I_{NC(PWROFF)}$, $I_{NO(PWROFF)}$	V_{NC} or V_{NO} = 0 to 2.7 V, V_{COM} = 2.7 V to 0,	Switch OFF, See Figure 14	25°C	0 V	−1		1	µA
				Full		−10		10	
NC, NO ON leakage current	$I_{NC(ON)}$, $I_{NO(ON)}$	V_{NC} or V_{NO} = 0.5 V, V_{COM} = Open, or V_{NC} or V_{NO} = 2.3 V, V_{COM} = Open,	Switch ON, See Figure 15	25°C	2.7 V	−20		20	nA
				Full		−50		50	
COM OFF leakage current	$I_{COM(OFF)}$	V_{COM} = 0.5 V, V_{NC} or V_{NO} = 2.3 V, or V_{COM} = 2.3 V, V_{NC} or V_{NO} = 0.5V,	Switch OFF, See Figure 14	25°C	2.7 V	−20		20	nA
				Full		−50		50	
	$I_{COM(PWROFF)}$	V_{NC} or V_{NO} = 0 to 2.7 V, V_{COM} = 2.7 V to 0,	Switch OFF, See Figure 14	25°C	0 V	−1		1	µA
				Full		−10		10	
COM ON leakage current	$I_{COM(ON)}$	V_{COM} = 0.5 V, V_{NC} or V_{NO} = Open, or V_{COM} = 2.3 V, V_{NC} or V_{NO} = Open,	Switch ON, See Figure 15	25°C	2.7 V	−20		20	nA
				Full		−50		50	
Digital Control Inputs (IN, $\overline{EN}$)[2]									
Input logic high	V_{IH}			Full		1.8		5.5	V
Input logic low	V_{IL}			Full		0		0.6	V
Input leakage current	I_{IH}, I_{IL}	V_I = 5.5 V or 0		25°C	2.7 V	−100	25	100	nA
				Full		−100		100	

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.
(2) All unused digital inputs of the device must be held at V_+ or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

Electrical Characteristics for 2.5-V Supply (continued)

V_+ = 3 V to 3.6 V, T_A = −40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T_A	V_+	MIN	TYP	MAX	UNIT
Dynamic									
Turn-on time, IN or $\overline{OE}$	t_{ON}	$V_{COM} = V_+$, $R_L = 50\ \Omega$,	$C_L = 35$ pF, See Figure 17	25°C	2.5 V	4	7.0	11.5	ns
				Full	2.3 V to 2.7 V	3.5		12	
Turn-off time, IN or $\overline{OE}$	t_{OFF}	$V_{COM} = V_+$, $R_L = 50\ \Omega$,	$C_L = 35$ pF, See Figure 17	25°C	2.5 V	5	11.5	18.5	ns
				Full	2.3 V to 2.7 V	4		21	
Make-before-break time	t_{MBB}	$V_{COM} = V_+$, $R_L = 50\ \Omega$,	$C_L = 35$ pF, See Figure 18	25°C	2.5 V	4	6.3	15	ns
				Full	2.3 V to 2.7 V	4		16	
Charge injection	Q_C	$V_{GEN} = 0$, $R_{GEN} = 0$,	$C_L = 1$ nF, See Figure 22	25°C	2.5 V		7		pC
NC, NO OFF capacitance	$C_{NC(OFF)}$, $C_{NO(OFF)}$	V_{NC} or $V_{NO} = V_+$ or GND,	Switch OFF, See Figure 16	25°C	2.5 V		19		pF
NC, NO ON capacitance	$C_{NC(ON)}$, $C_{NO(ON)}$	V_{NC} or $V_{NO} = V_+$ or GND,	Switch ON, See Figure 16	25°C	2.5 V		57		pF
COM OFF capacitance	$C_{COM(OFF)}$	$V_{COM} = V_+$ or GND,	Switch ON, See Figure 16	25°C	2.5 V		36		pF
COM ON capacitance	$C_{COM(ON)}$	$V_{COM} = V_+$ or GND,	Switch ON, See Figure 16	25°C	2.5 V		57		pF
Digital input capacitance	C_I	$V_I = V_+$ or GND,	See Figure 16	25°C	2.5 V		2		pF
Bandwidth	BW	$R_L = 50\ \Omega$,	Switch ON, See Figure 19	25°C	2.5 V		100		MHz
OFF isolation	O_{ISO}	$R_L = 50\ \Omega$, $f = 1$ MHz,	Switch OFF, See Figure 20	25°C	2.5 V		−64		dB
Crosstalk	X_{TALK}	$R_L = 50\ \Omega$, $f = 1$ MHz,	Switch ON, See Figure 21	25°C	2.5 V		−64		dB
Total harmonic distortion	THD	$R_L = 600\ \Omega$, $C_L = 50$ pF,	$f = 20$ Hz to 20 kHz, See Figure 23	25°C	2.5 V		0.020		%
Supply									
Positive supply current	I_+	$V_I = V_+$ or GND,	Switch ON or OFF	25°C	2.7 V		0.001	0.05	μA
				Full				0.15	

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TS5A3154

Electrical Characteristics for 1.8-V Supply[1]

V_+ = 1.65 V to 1.95 V, T_A = −40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T_A	V_+	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V_{COM}, V_{NO}, V_{NC}					0		V_+	V
Peak ON resistance	r_{peak}	$0 ≤ (V_{NO}$ or $V_{NC}) ≤ V_+$, I_{COM} = −2 mA,	Switch ON, See Figure 13	25°C	1.65 V		5.5	25	Ω
				Full				30	
ON-state resistance	r_{on}	V_{NO} or V_{NC} = 1.5 V, I_{COM} = −2 mA,	Switch ON, See Figure 13	25°C	1.65 V		2	2.7	Ω
				Full				3.1	
ON-state resistance matching between channels	$Δr_{on}$	V_{NO} or V_{NC} = 1.5 V, I_{COM} = −2 mA,	Switch ON, See Figure 13	25°C	1.65 V		0.16	0.3	Ω
				Full				0.3	
ON-state resistance flatness	$r_{on(flat)}$	$0 ≤ (V_{NO}$ or $V_{NC}) ≤ V_+$, I_{COM} = −2 mA,	Switch ON, See Figure 13	25°C	1.65 V		3		Ω
		V_{NO} or V_{NC} = 0.6 V, 1.5 V, I_{COM} = −2 mA,	Switch ON, See Figure 13	25°C			3	20	
				Full				25	
NC, NO OFF leakage current	$I_{NC(OFF)}$, $I_{NO(OFF)}$	V_{NC} or V_{NO} = 0.3 V, V_{COM} = 1.65 V, or V_{NC} or V_{NO} = 1.65 V, V_{COM} = 0.3 V,	Switch OFF, See Figure 14	25°C	1.95 V	−20	1.5	20	nA
				Full		−50		50	
	$I_{NC(PWROFF)}$, $I_{NO(PWROFF)}$	V_{NC} or V_{NO} = 0 to 1.95 V, V_{COM} = 1.95 V to 0,	Switch OFF, See Figure 14	25°C	0 V	−1	0.1	1	μA
				Full		−10		10	
NC, NO ON leakage current	$I_{NC(ON)}$, $I_{NO(ON)}$	V_{NC} or V_{NO} = 0.3 V, V_{COM} = Open, or V_{NC} or V_{NO} = 1.65 V, V_{COM} = Open,	Switch ON, See Figure 15	25°C	1.95 V	−20	1.5	20	nA
				Full		−50		50	
COM OFF leakage current	$I_{COM(OFF)}$	V_{NC} or V_{NO} = 1.65 V, V_{COM} = 0.3 V, or V_{NC} or V_{NO} = 0.3 V, V_{COM} = 1.65 V,	Switch OFF, See Figure 14	25°C	1.95 V	−20	1.5	20	nA
				Full		−50		50	
	$I_{COM(PWROFF)}$	V_{NC} or V_{NO} = 1.95 V to 0, V_{COM} = 0 to 1.95 V,	Switch OFF, See Figure 14	25°C	0 V	−1	0.06	1	μA
				Full		−10		10	
COM ON leakage current	$I_{COM(ON)}$	V_{NC} or V_{NO} = Open, V_{COM} = 0.3 V, or V_{NC} or V_{NO} = Open, V_{COM} = 1.65 V,	Switch ON, See Figure 15	25°C	1.95 V	−20	1.5	20	nA
				Full		−50		50	
Digital Control Inputs (IN, $\overline{EN}$)[2]									
Input logic high	V_{IH}			Full		1.5		5.6	V
Input logic low	V_{IL}			Full		0		0.6	V
Input leakage current	I_{IH}, I_{IL}	V_I = 5.5 V or 0		25°C	1.95 V	−100	25	100	nA
				Full		−100		100	

(1)   The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(2)   All unused digital inputs of the device must be held at V_+ or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

Electrical Characteristics for 1.8-V Supply (continued)

V_+ = 1.65 V to 1.95 V, T_A = −40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T_A	V_+	MIN	TYP	MAX	UNIT
Dynamic									
Turn-on time, IN or $\overline{OE}$	t_{ON}	$V_{COM} = V_+$, R_L = 50 Ω,	C_L = 35 pF, See Figure 17	25°C	5 V	5		20.5	ns
				Full	1.65 V to 1.95 V	4.5		21	
Turn-off time, IN or $\overline{OE}$	t_{OFF}	$V_{COM} = V_+$, R_L = 50 Ω,	C_L = 35 pF, See Figure 17	25°C	5 V	7	16.5	27.5	ns
				Full	1.65 V to 1.95 V	5		30	
Make-before-break time	t_{MBB}	$V_{COM} = V_+$, R_L = 50 Ω,	C_L = 35 pF, See Figure 18	25°C	5 V	4	8.3	15	ns
				Full	1.65 V to 1.95 V	4		16	
Charge injection	Q_C	V_{GEN} = 0, R_{GEN} = 0,	C_L = 1 nF, See Figure 22	25°C	1.8 V		5		pC
NC, NO OFF capacitance	$C_{NC(OFF)}$, $C_{NO(OFF)}$	V_{NC} or $V_{NO} = V_+$ or GND,	Switch OFF, See Figure 16	25°C	1.8 V		19		pF
NC, NO ON capacitance	$C_{NC(ON)}$, $C_{NO(ON)}$	V_{NC} or $V_{NO} = V_+$ or GND,	Switch ON, See Figure 16	25°C	1.8 V		57		pF
COM OFF capacitance	$C_{COM(OFF)}$	$V_{COM} = V_+$ or GND,	Switch ON, See Figure 16	25°C	1.8 V		36		pF
COM ON capacitance	$C_{COM(ON)}$	$V_{COM} = V_+$ or GND,	Switch ON, See Figure 16	25°C	1.8 V		57		pF
Digital input capacitance	C_I	$V_I = V_+$ or GND,	See Figure 16	25°C	1.8 V		2.0		pF
Bandwidth	BW	R_L = 50 Ω,	Switch ON, See Figure 19	25°C	1.8 V		100		MHz
OFF isolation	O_{ISO}	R_L = 50 Ω, f = 1 MHz,	Switch OFF, See Figure 20	25°C	1.8 V		−64		dB
Crosstalk	X_{TALK}	R_L = 50 Ω, f = 1 MHz,	Switch ON, See Figure 21	25°C	1.8 V		−64		dB
Total harmonic distortion	THD	R_L = 600 Ω, C_L = 50 pF,	f = 20 Hz to 20 kHz, See Figure 23	25°C	1.8 V		0.060		%
Supply									
Positive supply current	I_+	$V_I = V_+$ or GND,	Switch ON or OFF	25°C	1.95 V		0.001	0.05	μA
				Full				0.1	

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Product Folder Link(s): *TS5A3154*

TS5A3154

TYPICAL PERFORMANCE
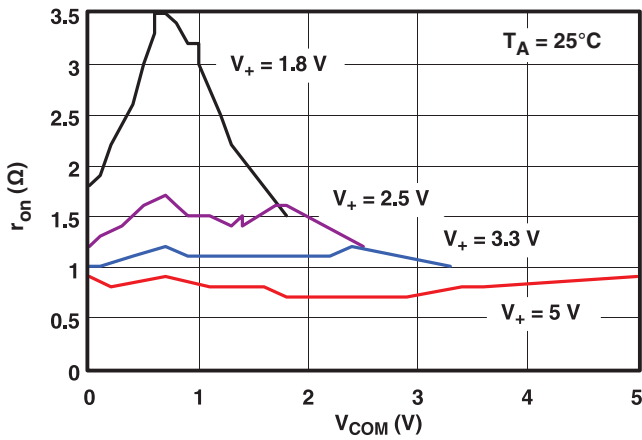
Figure 1. r_{on} vs V_{COM}
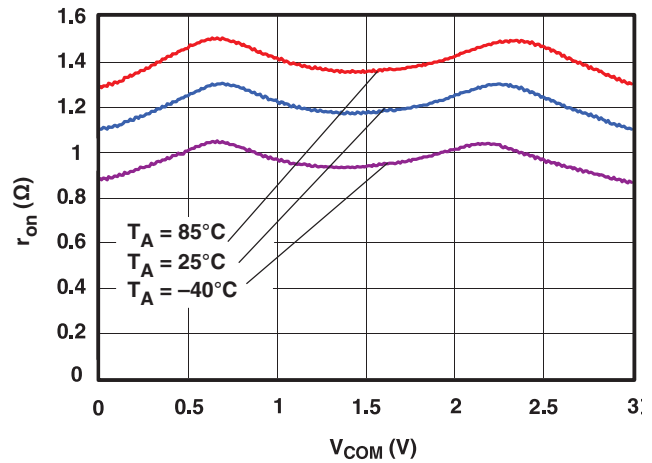
Figure 2. r_{on} vs V_{COM} ($V_+ = 3$ V)
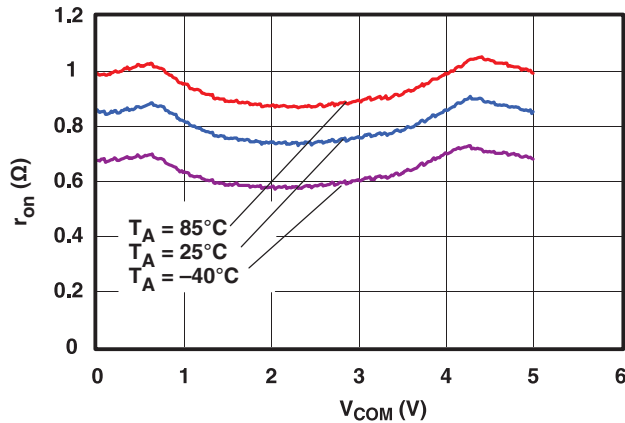
Figure 3. r_{on} vs V_{COM} ($V_+ = 5$ V)
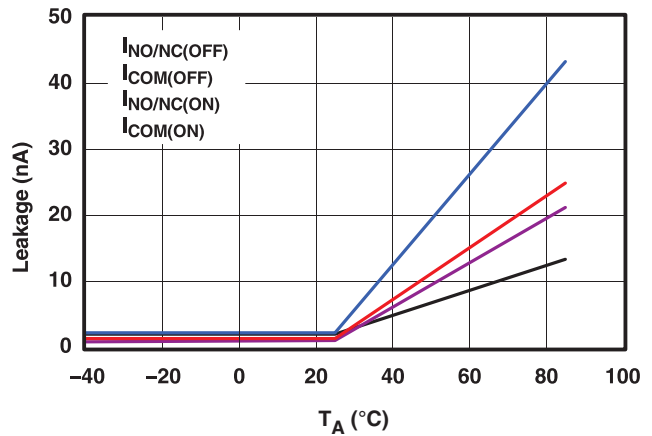
Figure 4. Leakage Current vs Temperature
($V_+ = 5.5$ V)
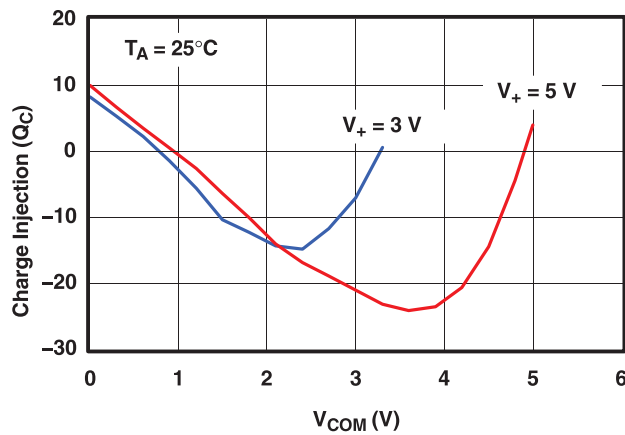
Figure 5. Charge Injection (Q_C) vs V_{COM}
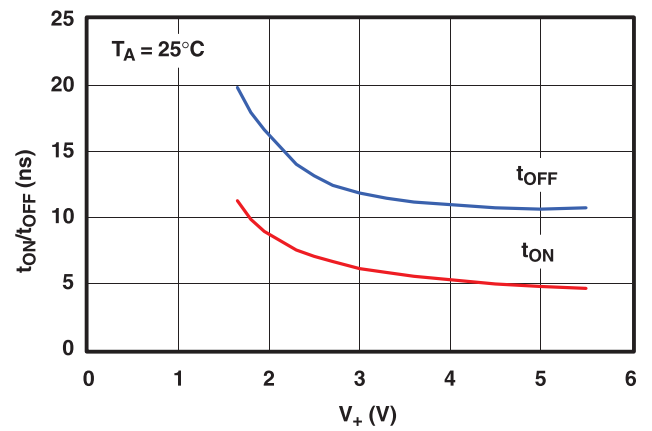
Figure 6. t_{ON} and t_{OFF} vs Supply Voltage

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TYPICAL PERFORMANCE (continued)
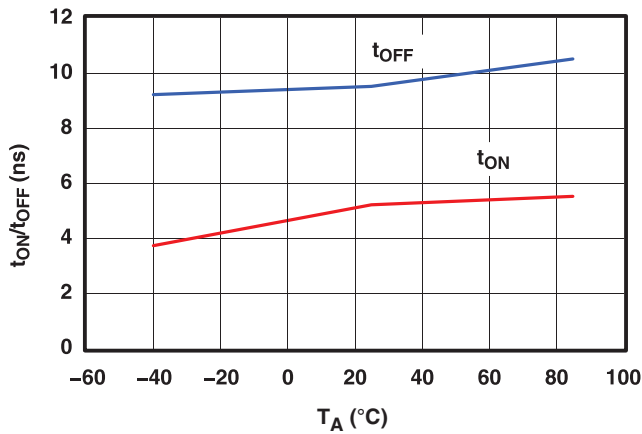
Figure 7. t_{ON} and t_{OFF} vs Temperature (V_+ = 5 V)
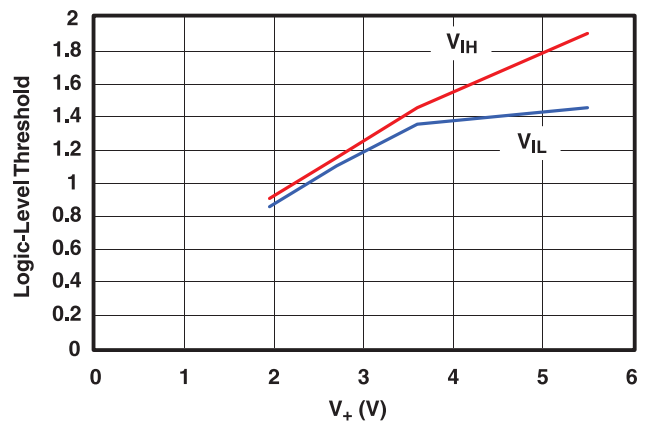
Figure 8. Logic-Level Threshold vs V_+
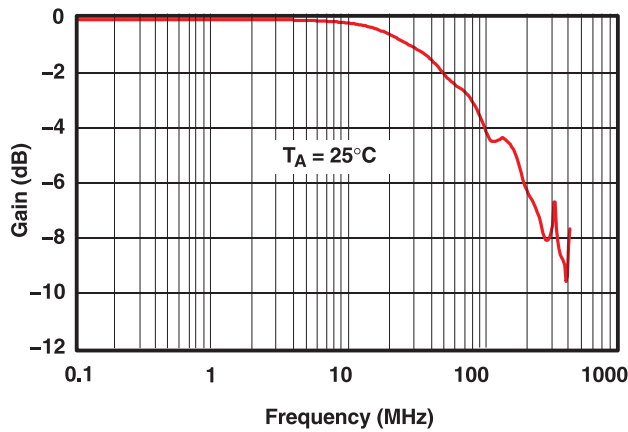
Figure 9. Bandwidth (V_+ = 5 V)
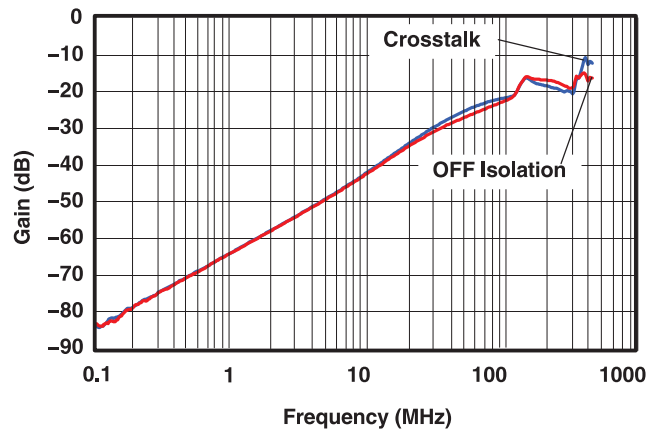
Figure 10. OFF Isolation and Crosstalk (V_+ = 5 V)
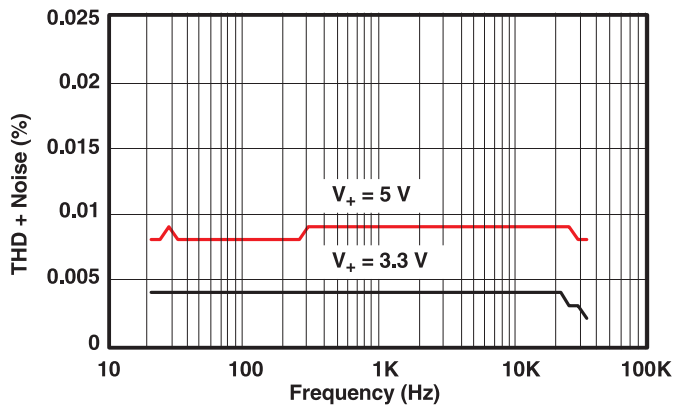
Figure 11. Total Harmonic Distortion (THD)
vs Frequency
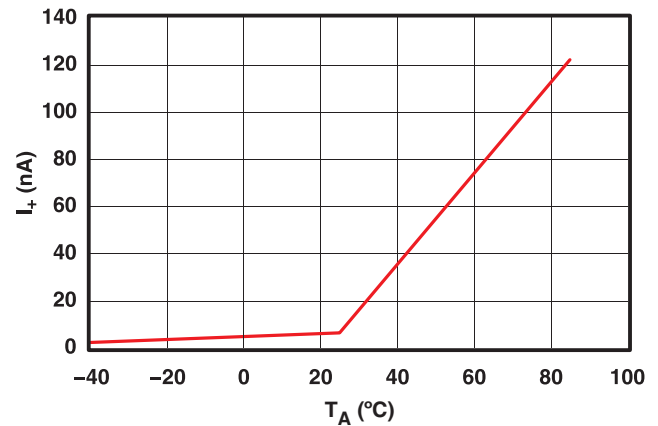
Figure 12. Power Supply Current vs Temperature
(V_+ = 5 V)

TS5A3154

PIN DESCRIPTION

PIN NO.	NAME	DESCRIPTION
1	COM	Common
2	$\overline{\text{EN}}$	Enable control input
3	GND	Digital ground
4	GND	Digital ground
5	IN	Digital control to connect the COM to NO or NC
6	NO	Normally open
7	NC	Normally closed
8	V_+	Power supply

PARAMETER DESCRIPTION

SYMBOL	DESCRIPTION
V_{COM}	Voltage at COM
V_{NC}	Voltage at NC
V_{NO}	Voltage at NO
r_{on}	Resistance between COM and NC or COM and NO ports when the channel is ON
Δr_{on}	Difference of r_{on} between channels in a specific device
$r_{on(flat)}$	Difference between the maximum and minimum value of r_{on} in a channel over the specified range of conditions
$I_{NC(OFF)}$	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the OFF state
$I_{NO(OFF)}$	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state
$I_{NC(ON)}$	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the ON state and the output (COM) open
$I_{NO(ON)}$	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) open
$I_{COM(ON)}$	Leakage current measured at the COM port, with the corresponding channel (COM to NO or COM to NC) in the ON state and the output (NC or NO) open
V_{IH}	Minimum input voltage for logic high for the control input (IN)
V_{IL}	Maximum input voltage for logic low for the control input (IN)
V_I	Voltage at the control input (IN)
I_{IH}, I_{IL}	Leakage current measured at the control input (IN)
t_{ON}	Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM, NC, or NO) signal when the switch is turning ON.
t_{OFF}	Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM, NC, or NO) signal when the switch is turning OFF.
t_{BBM}	Break-before-make time. This parameter is measured under the specified range of conditions and by the propagation delay between the output of two adjacent analog channels (NC and NO) when the control signal changes state.
Q_C	Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NC, NO, or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_{COM}$, C_L is the load capacitance and ΔV_{COM} is the change in analog output voltage.
$C_{NC(OFF)}$	Capacitance at the NC port when the corresponding channel (NC to COM) is OFF
$C_{NO(OFF)}$	Capacitance at the NO port when the corresponding channel (NO to COM) is OFF
$C_{NC(ON)}$	Capacitance at the NC port when the corresponding channel (NC to COM) is ON
$C_{NO(ON)}$	Capacitance at the NO port when the corresponding channel (NO to COM) is ON
$C_{COM(ON)}$	Capacitance at the COM port when the corresponding channel (COM to NC or COM to NO) is ON
C_I	Capacitance of control input (IN)
O_{ISO}	OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NC to COM or NO to COM) in the OFF state.
X_{TALK}	Crosstalk is a measurement of unwanted signal coupling from an ON channel to an OFF channel (NC to NO or NO to NC). This is measured in a specific frequency and in dB.
BW	Bandwidth of the switch. This is the frequency where the gain of an ON channel is −3 dB below the DC gain.

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PARAMETER DESCRIPTION (continued)

SYMBOL	DESCRIPTION
THD	Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of fundamental harmonic.
I_+	Static power-supply current with the control (IN) pin at V_+ or GND

PARAMETER MEASUREMENT INFORMATION

Channel ON

$$r_{on} = \frac{V_{COM} - V_{NO} \text{ or } V_{NC}}{I_{COM}} \ \Omega$$

$V_I = V_{IH}$ or V_{IL}
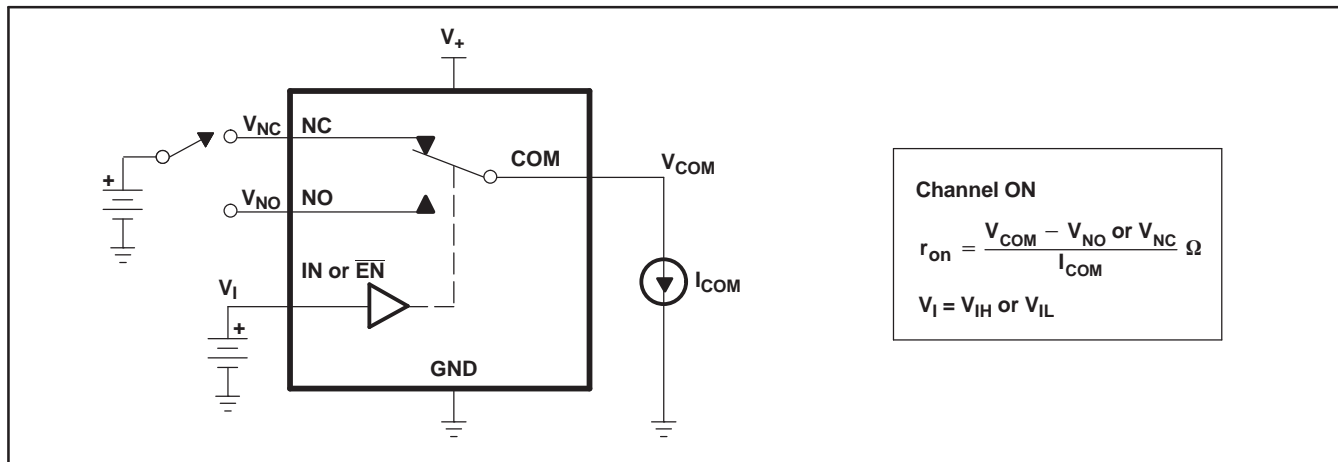
Figure 13. ON-State Resistance (r_{on})

OFF-State Leakage Current
Channel OFF
$V_I = V_{IH}$ or V_{IL}
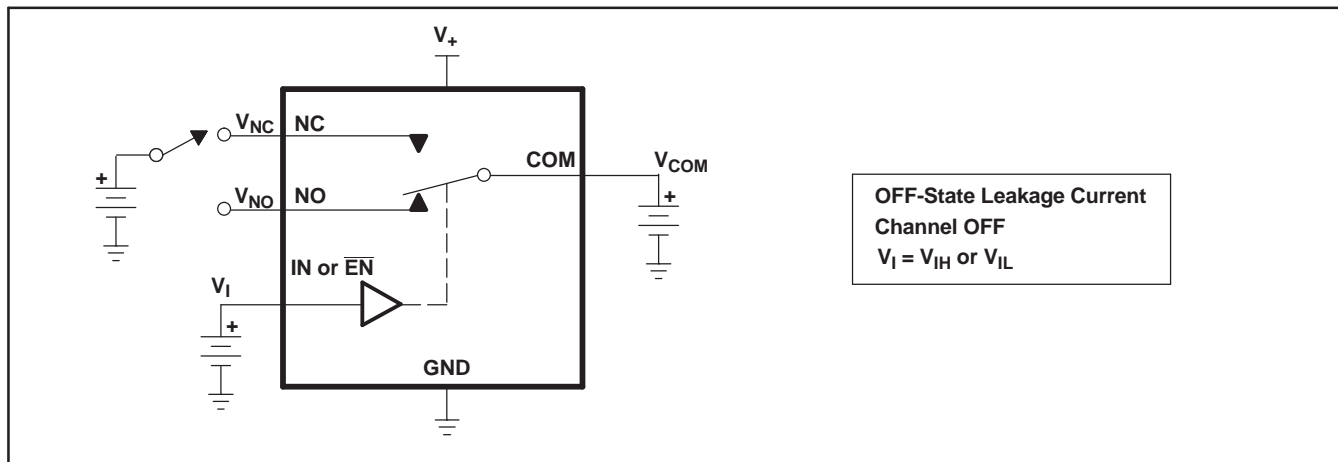
Figure 14. OFF-State Leakage Current ($I_{NC(OFF)}$, $I_{NO(OFF)}$, $I_{NO(PWROFF)}$, $I_{COM(PWROFF)}$)

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PARAMETER MEASUREMENT INFORMATION (continued)
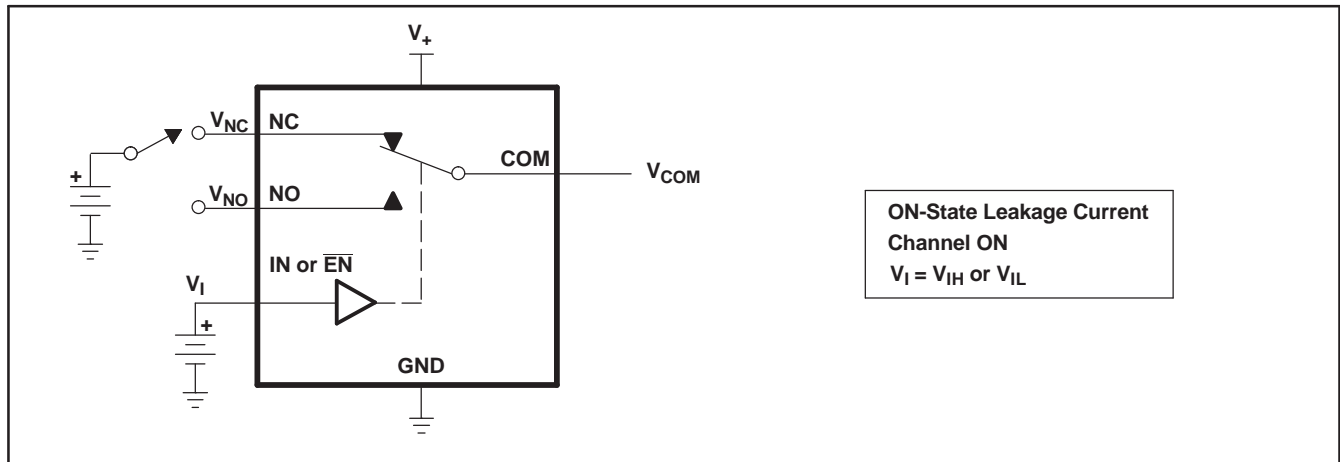
Figure 15. ON-State Leakage Current ($I_{COM(ON)}$, $I_{NC(ON)}$, $I_{NO(ON)}$)
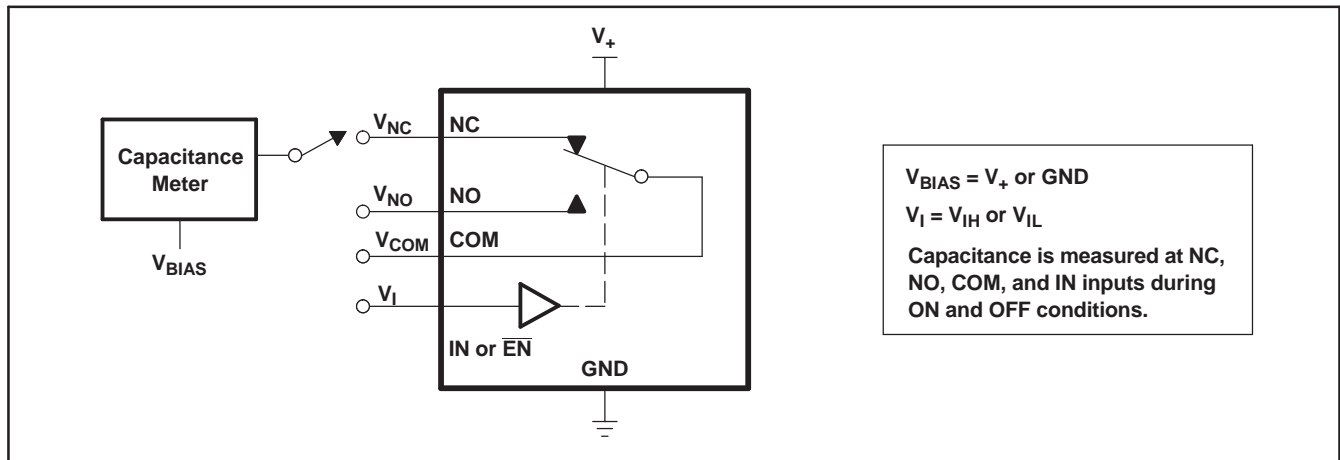
Figure 16. Capacitance (C_I, $C_{COM(OFF)}$, $C_{COM(ON)}$, $C_{NC(OFF)}$, $C_{NO(OFF)}$, $C_{NC(ON)}$, $C_{NO(ON)}$)

Product Folder Link(s): *TS5A3154*
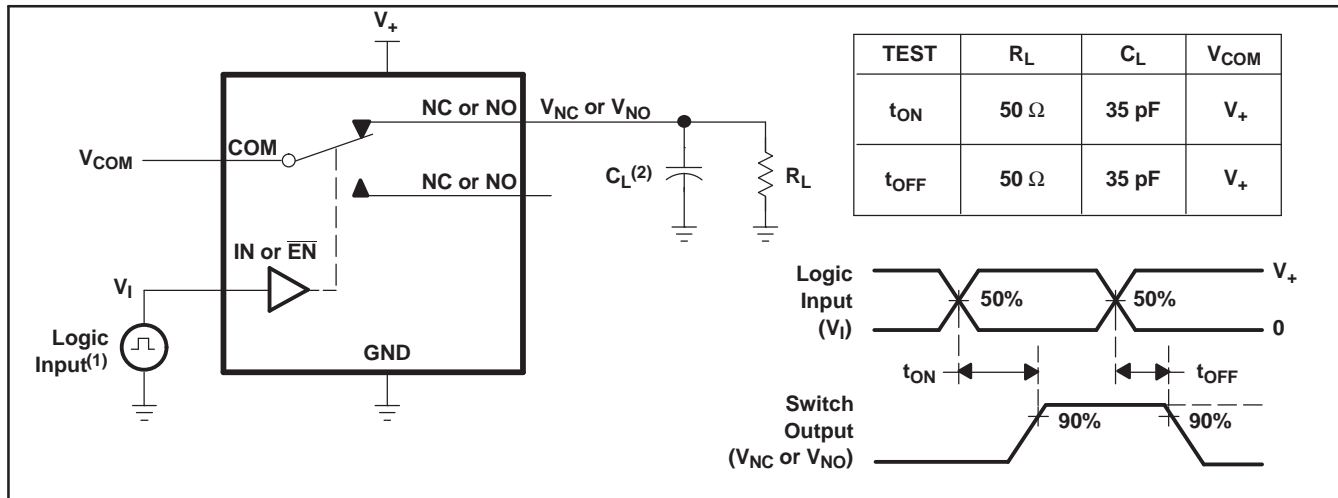
PARAMETER MEASUREMENT INFORMATION (continued)

TEST	R_L	C_L	V_{COM}
t_{ON}	50 Ω	35 pF	V_+
t_{OFF}	50 Ω	35 pF	V_+

(1) All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r < 5 ns, t_f < 5 ns.
(2) C_L includes probe and jig capacitance.

Figure 17. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})
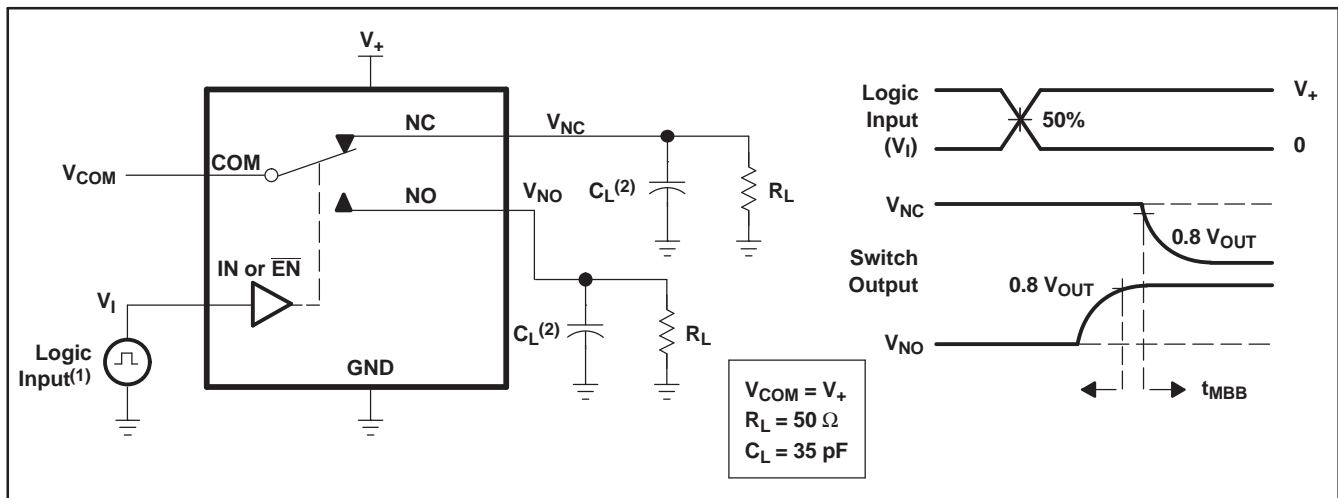
(1) All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r < 5 ns, t_f < 5 ns.
(2) C_L includes probe and jig capacitance.

Figure 18. Make-Before-Break Time (t_{MBB})

PARAMETER MEASUREMENT INFORMATION (continued)
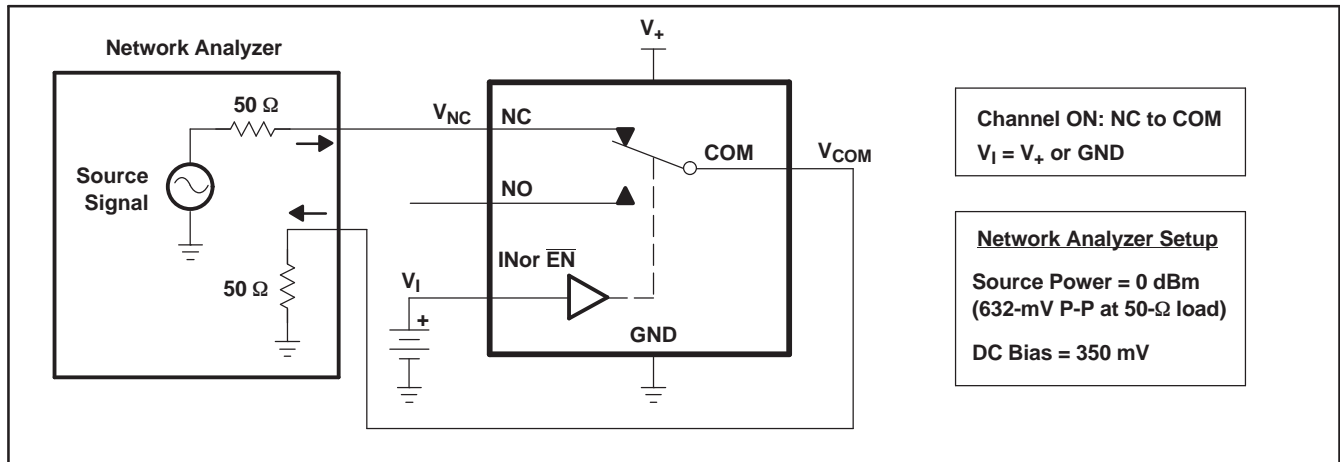
Figure 19. Bandwidth (BW)
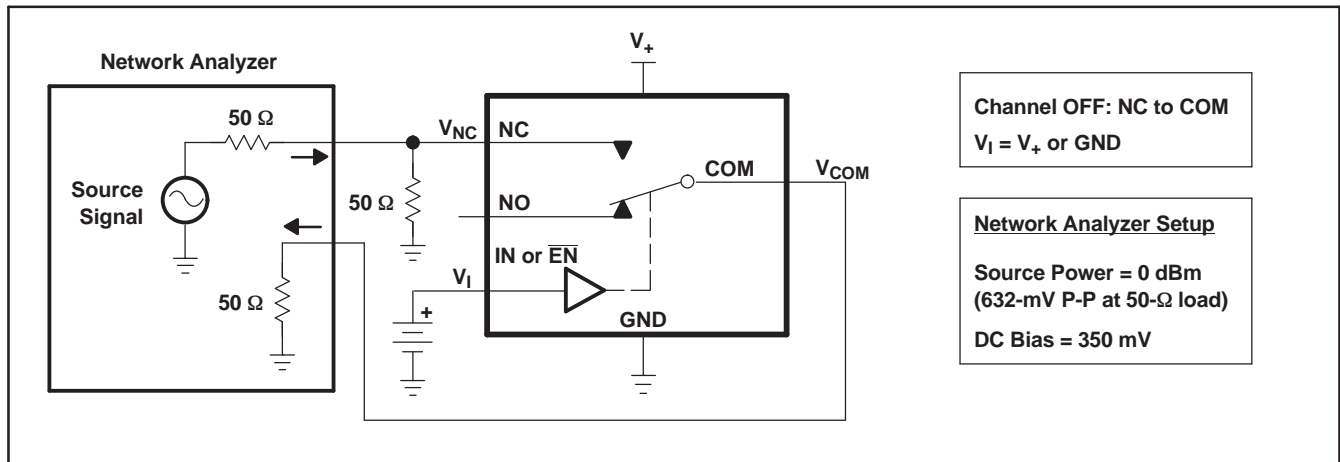
Figure 20. OFF Isolation (O$_{ISO}$)
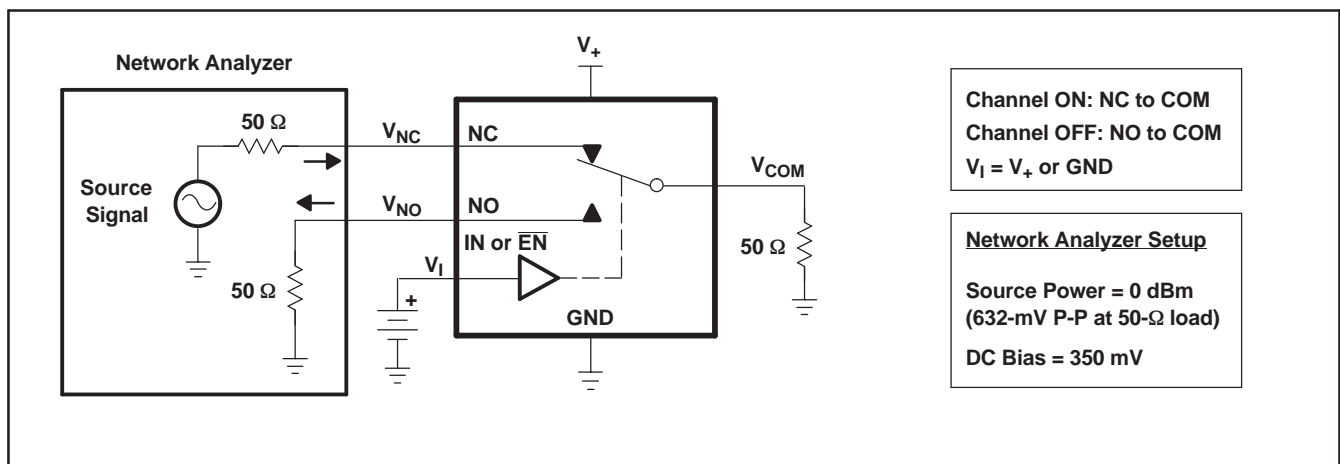
Figure 21. Crosstalk (X$_{TALK}$)

PARAMETER MEASUREMENT INFORMATION (continued)
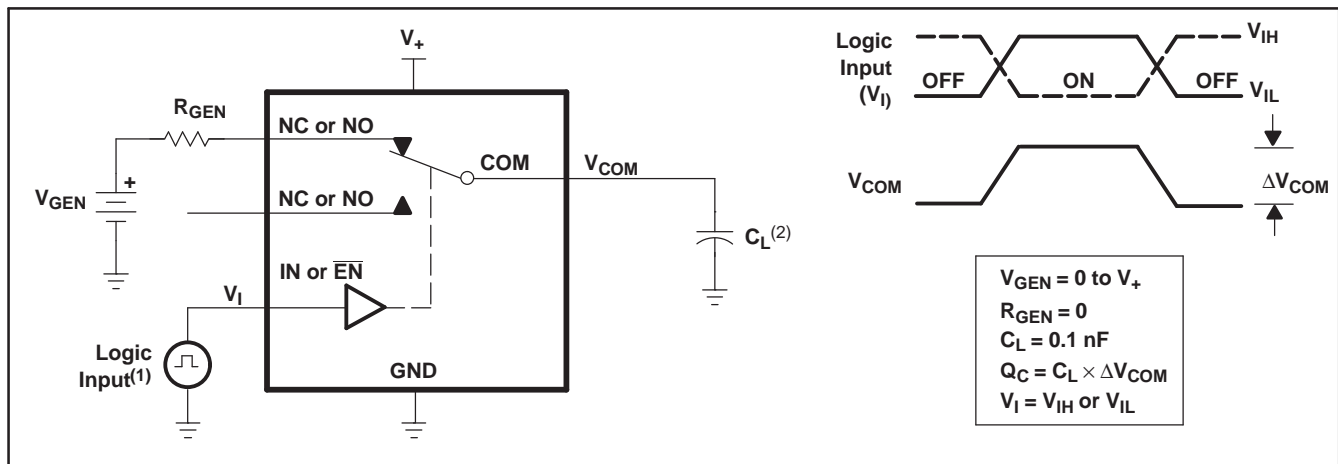
[1] All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, $Z_O = 50 \Omega$, $t_r < 5$ ns, $t_f < 5$ ns.
[2] C_L includes probe and jig capacitance.

Figure 22. Charge Injection (Q_C)
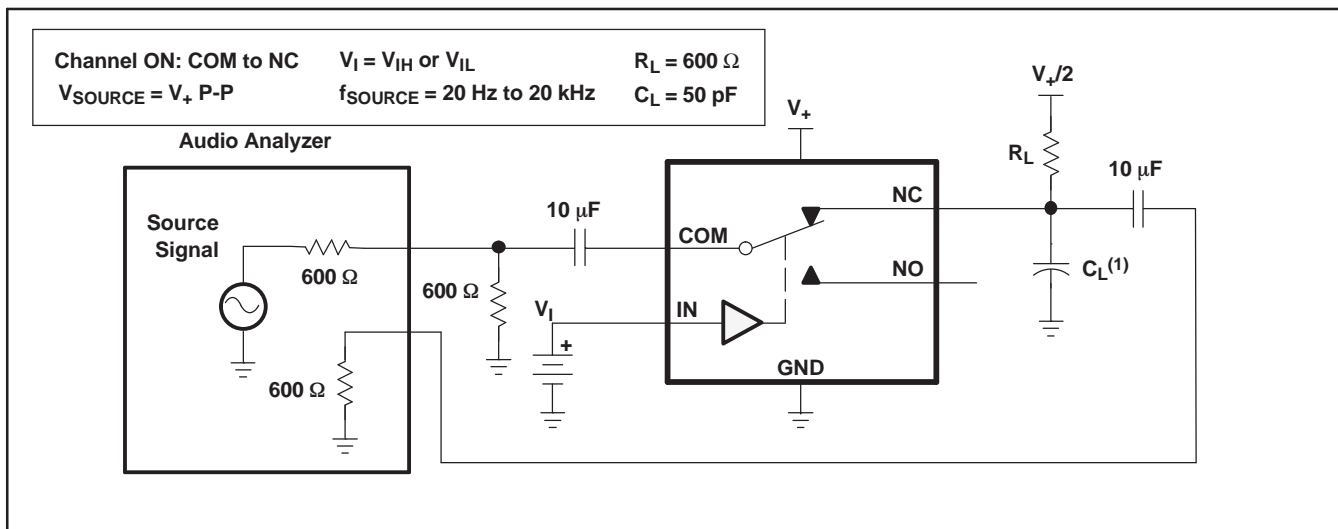
[1] C_L includes probe and jig capacitance.

Figure 23. Total Harmonic Distortion (THD)

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
TS5A3154DCUR	ACTIVE	US8	DCU	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TS5A3154DCURE4	ACTIVE	US8	DCU	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TS5A3154DCURE6	PREVIEW	US8	DCU	8	3000	TBD	Call TI	Call TI
TS5A3154DCURG4	ACTIVE	US8	DCU	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TS5A3154YZPR	ACTIVE	DSBGA	YZP	8	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

PACKAGE MATERIALS INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TS5A3154DCUR	US8	DCU	8	3000	180.0	9.2	2.25	3.35	1.05	4.0	8.0	Q3
TS5A3154YZPR	DSBGA	YZP	8	3000	180.0	8.4	1.02	2.02	0.63	4.0	8.0	Q1

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TS5A3154DCUR	US8	DCU	8	3000	202.0	201.0	28.0
TS5A3154YZPR	DSBGA	YZP	8	3000	220.0	220.0	34.0

DCU (R−PDSO−G8)   PLASTIC SMALL−OUTLINE PACKAGE (DIE DOWN)

0,50

0,25
0,17

⊕ | 0,08 Ⓜ

8   5

2,40
2,20

3,20
3,00

PIN 1
INDEX AREA

1   4

2,10
1,90

0,13 NOM

Gage Plane

0°−6°

0,12

0,35
0,20

0,90
0,60

0,10
0,00

Seating Plane

⌓ | 0,10

4200503/F 07/05

NOTES: A. All linear dimensions are in millimeters.
         B. This drawing is subject to change without notice.
         C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
         D. Falls within JEDEC MO−187 variation CA.

DCU (S−PDSO−G8)   PLASTIC SMALL OUTLINE PACKAGE (DIE DOWN)

Example Board Layout
(Note C,E)

Example Stencil Design
(Note D)

6x 0,5

8x 0,25

6x 0,5

8x 0,75

3,1

3,1

0,3

Example
Solder Mask Opening

0,8

Pad Geometry

0,05

All Around

4210064/B 05/10

NOTES: A. All linear dimensions are in millimeters.
         B. This drawing is subject to change without notice.
         C. Publication IPC−7351 is recommended for alternate designs.
         D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers
             should contact their board assembly site for stencil design recommendations. Refer to IPC−7525.
         E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

YZP (R−XBGA−N8)   DIE−SIZE BALL GRID ARRAY

0,95
0,85

[A]   [B]

1,95
1,85

Ball A1 Index Area

0,50

0,25

D
C
B
A

1   2

Bottom View

1,50

0,25

0,50

8X ⌀ 0,25 / 0,21

⊕ ⌀ 0,015 (M) | C | A | B

0,50 Max

⌒ 0,05 | C

Seating Plane

0,19
0,15

[C]

4204741−4/G 07/2008
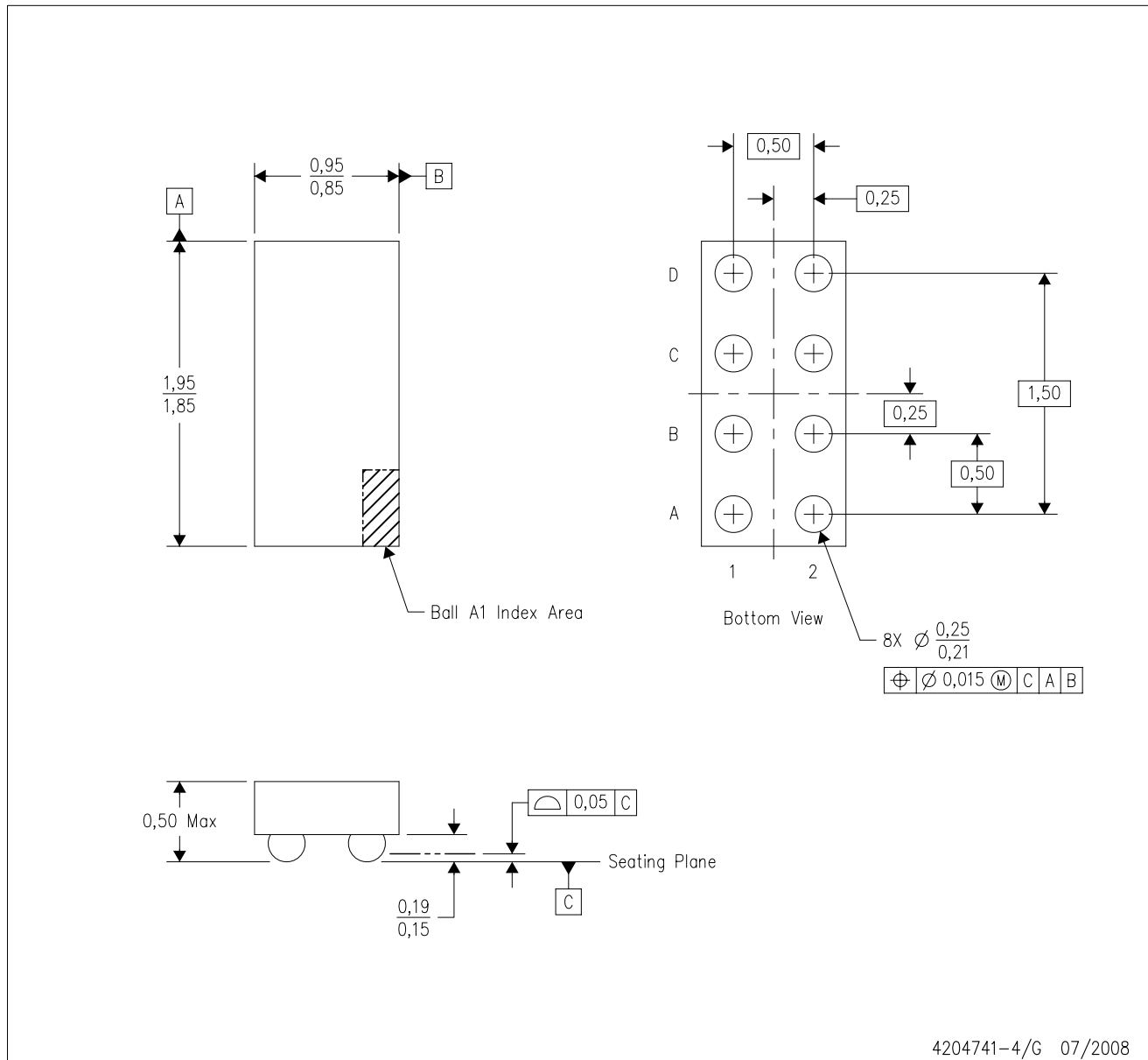
NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M−1994.
         B. This drawing is subject to change without notice.
         C. NanoFree™ package configuration.
         D. This package is lead−free. Refer to the 8 YEP package (drawing 4204725) for tin−lead (SnPb).

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